

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HAYATO KURITA	07/21/2017
KAZUYOSHI KANEKO	07/21/2017
MASAHIRO ENNA	07/21/2017
TATSUYA ENOMOTO	07/21/2017
HIDEKI MOCHIZUKI	07/21/2017
RECEIVING PARTY DATA	
Name:	MITSUI CHEMICALS, INC.
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State/Country:	JAPAN
Postal Code:	1057122
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15558137
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NAME OF SUBMITTER:	MICHAEL D. KAMINSKI
SIGNATURE:	/Michael D. Kaminski, Reg. No. 32,904/
DATE SIGNED:	09/13/2017

Total Attachments: 2

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Assignment of Application

INSERT NAMES
AND RESIDENCE
ADDRESS OF
THE INVENTORS:

WHEREAS, I (WE) 1) Hayato KURITA of c/o MITSUI CHEMICALS, INC., 580-32, Nagaura, Sodegaura-shi, Chiba 2990265 Japan, 2) Kazuyoshi KANEKO of c/o SUN ALLOYS CO., LTD., 580-271, Nagaura, Sodegaura-shi, Chiba 2990265 Japan, 3) Masahiro ENNA and 4) Tatsuya ENOMOTO of c/o MITSUI CHEMICALS, INC., 580-32, Nagaura, Sodegaura-shi, Chiba 2990265 Japan, 5) Hideki MOCHIZUKI of c/o MITSUI CHEMICALS, INC., 5-2, Higashi-Shimbashi 1-chome, Minato-ku, Tokyo 1057122 Japan, respectively,

INSERT TITLE OF
INVENTION:

have invented certain new and useful improvements in: "THERMOPLASTIC ELASTOMER COMPOSITION AND PRODUCTION PROCESS FOR THE SAME"

(Application No. _____, filed _____), and

INSERT NAMES
AND ADDRESS OF
COMPANY OR
OTHER ASSIGNEE

WHEREAS, MITSUI CHEMICALS, INC.

(hereinafter referred to as "ASSIGNEE") having a place of business at : 5-2, Higashi-Shimbashi 1-chome, Minato-ku, Tokyo 1057122 Japan is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I(WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letter Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of FOLEY & LARDNER LLP of WASHINGTON HARBOUR
3000 K STREET, N.W.,
SUITE 600
WASHINGTON D.C. 20007-5109

U.S.A. the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: July 21, 2017 *Hayato Kurita*
(Signature of Inventor) Hayato KURITA

Date: July 21, 2017 *Kazuyoshi Kaneko*
(Signature of Inventor) Kazuyoshi KANEKO

Date: July 21, 2017 *Masahiro Enna*
(Signature of Inventor) Masahiro ENNA

Date: July 21, 2017 *Tatsuya Enomoto*
(Signature of Inventor) Tatsuya ENOMOTO

Date: July 21, 2017 *Hideki Mochizuki*
(Signature of Inventor) Hideki MOCHIZUKI

Date: _____
(Signature of Inventor)

Date: _____
(Signature of Inventor)

Date: _____
(Signature of Inventor)

Date: _____
(Signature of Inventor)

Date: _____
(Signature of Inventor)